

Date: May 16, 1995

Reference: Standards Proposal No. 3389, Proposed New Standard "PCS  
1900 Air Interface Specification" (if approved, to be published  
as J-STD-007)

Company Name: Hitachi Telecom (USA), Inc.

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NOTE: If not attached, indicate when the envelope will be received at TIA. Indicate the company name and proposed Standard number on the outside. Date due at TIA: \_\_\_\_\_

Agreed, on behalf of the above Company: Michael W Medin  
(Signature)

Name (printed): Michael Medin

Date: 7/14/95